

RELIABILITY REPORT FOR ICL7662CBA+

PLASTIC ENCAPSULATED DEVICES

December 21, 2008

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR. SUNNYVALE, CA 94086

| Approved by |
|-----------------------------------|
| Ken Wendel |
| Quality Assurance |
| Director, Reliability Engineering |



Conclusion

The ICL7662CBA+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim"s continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim"s quality and reliability standards.

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I. Device Description

A. General

The ICL7662/Si7661 is a monolithic charge pump voltage inverter that will convert a positive voltage in the range of +4.5V to +20.0V to the corresponding negative voltage of -4.5V to -20.0V. The ICL7662/Si7661 provides performance far superior to previous charge pump voltage inverters by combining low quiescent current with high efficiency. The ICL7662/Si7661 has an oscillator, control circuitry, and four power MOS switches on-chip, with the only required external components being two low cost capacitors.



II. Manufacturing Information

B. Process:

| CMOS, Voltage Converters |
|--------------------------|
| M6H |

ATP Philippines, UTL Thailand, Carsem Malaysia

Oregon

Pre 1997

- C. Number of Device Transistors:
- D. Fabrication Location:

A. Description/Function:

- E. Assembly Location:
- F. Date of Initial Production:

III. Packaging Information

| A. Package Type: | 8-pin SOIC (N) |
|---|--------------------------|
| B. Lead Frame: | Copper |
| C. Lead Finish: | 100% matte Tin |
| D. Die Attach: | Conductive Epoxy |
| E. Bondwire: | Gold (1.3 mil dia.) |
| F. Mold Material: | Epoxy with silica filler |
| G. Assembly Diagram: | #05-0701-0562 |
| H. Flammability Rating: | Class UL94-V0 |
| I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C | Level 1 |
| J. Single Layer Theta Ja: | 170°C/W |
| K. Single Layer Theta Jc: | 40°C/W |
| L. Multi Layer Theta Ja: | 132°C/W |
| M. Multi Layer Theta Jc: | 38°C/W |
| | |

IV. Die Information

| wn) |
|------|
| awn) |
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V. Quality Assurance Information

| A. Quality Assurance Contacts: | Ken Wendel (Director, Reliability Engineering) Bryan Preeshl (Managing Director of QA) |
|-----------------------------------|--|
| B. Outgoing Inspection Level: | 0.1% for all electrical parameters guaranteed by the Datasheet.0.1% For all Visual Defects. |
| C. Observed Outgoing Defect Rate: | < 50 ppm |
| D. Sampling Plan: | Mil-Std-105D |

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

 $\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{1.83}_{192 \text{ x } 4340 \text{ x } 400 \text{ x } 2} \text{ (Chi square value for MTTF upper limit)} \\ \text{(where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)} \\ \lambda = 2.7 \text{ x } 10^{-9}$

𝔅 = 2.7 F.I.T. (60% confidence level @ 25°C)

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly 1000 hour life test monitors on its processes. This data is published in the Product Reliability Report found at http://www.maximic.com/. Current monitor data for the M6H Process results in a FIT Rate of 3.2 @ 25C and 54.8 @ 55C (0.8 eV, 60% UCL)

B. Moisture Resistance Tests

The industry standard 85°C/85%RH or HAST testing is monitored per device process once a quarter.

C. E.S.D. and Latch-Up Testing

The PS25 die type has been found to have all pins able to withstand a HBM transient pulse of +/-400 V per JEDEC JESD22-A114-D. Latch-Up testing has shown that this device withstands a current of +/-250 mA.



Table 1 Reliability Evaluation Test Results

ICL7662CBA+

| TEST ITEM | TEST CONDITION | FAILURE IDENTIFICATION | SAMPLE SIZE | NUMBER OF FAILURES | |
|------------------|-----------------|---------------------------|-------------|-----------------------|--|
| Static Life Test | (Note 1) | | | | |
| | Ta = 135°C | DC Parameters | 400 | 0 | |
| | Biased | & functionality | | | |
| | Time = 192 hrs. | , | | | |
| Moisture Testing | (Note 2) | | | | |
| 85/85 | Ta = 85°C | DC Parameters | 77 | 0 | |
| | RH = 85% | & functionality | | | |
| | Biased | | | | |
| | Time = 1000hrs. | | | | |
| Mechanical Stres | ss (Note 2) | | | | |
| Temperature | -65°C/150°C | DC Parameters | 77 | 0 | |
| Cycle | 1000 Cycles | & functionality | | | |
| | Method 1010 | | | | |

Note 1: Life Test Data may represent plastic DIP qualification lots.

Note 2: Generic Package/Process data